

# LNPTM THERMOCOMPTM COMPOUND UX08325

## **DESCRIPTION**

LNP THERMOCOMP UX08325 compound is based on Polyphthalamide (PPA) resin containing 30% glass fiber. Added features of this grade include: Improved Plating Surface and Mechanical Performance targeted for Laser Direct Structuring (LDS) applications, SMT Process capable.

GENERAL INFORMATION	
Features	Dielectrics, Laser Direct Structuring, High stiffness/Strength, High temperature resistance, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polyphthalamide (PPA)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Automotive	Automotive Interiors
Consumer	Personal Accessory
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical

## **TYPICAL PROPERTY VALUES**

PROPERTIES TYPICAL VALUES UNITS **TEST METHODS** MECHANICAL<sup>(1)</sup> Tensile Stress, brk, Type I, 5 mm/min 135 MPa ASTM D638 Tensile Strain, brk, Type I, 5 mm/min 18 ASTM D638 % MPa Tensile Modulus, 5 mm/min 10880 ASTM D638 197 Flexural Stress, yld, 1.3 mm/min, 50 mm span MPa ASTM D790 194 Flexural Stress, brk, 1.3 mm/min, 50 mm span MPa ASTM D790 9770 ASTM D790 Flexural Modulus, 1.3 mm/min, 50 mm span MPa Tensile Stress, break, 5 mm/min 125 MPa ISO 527 ISO 527 Tensile Strain, break, 5 mm/min 1.6 % 11080 ISO 527 Tensile Modulus, 1 mm/min MPa Flexural Stress, yield, 2 mm/min 194 MPa ISO 178 2 Flexural Strain, break, 2 mm/min ISO 178 % Flexural Modulus, 2 mm/min 9610 MPa ISO 178 IMPACT (1) Izod Impact, unnotched, 23°C 351 J/m ASTM D4812 31 Izod Impact, notched, 23°C ASTM D256 J/m Izod Impact, notched 80\*10\*4 +23°C 2 kJ/m² ISO 180/1A THERMAL (1) HDT, 1.82 MPa, 3.2mm, unannealed 263 °C ASTM D648 CTE, -40°C to 40°C, flow 2.2E-05 1/°C ASTM E831 CTE, -40°C to 40°C, xflow 5.4E-05 1/°C ASTM E831

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# CHEMISTRY THAT MATTERS

Revision 20241021



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	261	°C	ISO 75/Af
PHYSICAL <sup>(1)</sup>			
Density	1.55	g/cm <sup>3</sup>	ASTM D792
Mold Shrinkage, flow <sup>(2)</sup>	0.41	%	SABIC method
Mold Shrinkage, xflow <sup>(2)</sup>	0.52	%	SABIC method
Moisture Absorption (23°C / 50% RH)	0.53	%	ISO 62
ELECTRICAL <sup>(1)</sup>			
Relative Permittivity, 1 GHz	4.2	-	ASTM D150
Dissipation Factor, 1 GHz	0.01	-	ASTM D150
FLAME CHARACTERISTICS (3)			
UL Yellow Card Link	E207780-101334270	-	
UL Recognized, 94HB Flame Class Rating	≥1.5	mm	UL 94
INJECTION MOLDING (4)			
Drying Temperature	120 – 150	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.15	%	
Melt Temperature	315 – 330	°C	
Front - Zone 3 Temperature	325 – 340	°C	
Middle - Zone 2 Temperature	315 – 325	°C	
Rear - Zone 1 Temperature	310 – 320	°C	
Mold Temperature	140 – 165	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.

(4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

### **MORE INFORMATION**

For curve data and CAE cards, please visit and register at https://materialfinder.sabic-specialties.com

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